

# PATENT ASSIGNMENT

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Yasuhiro SHINDO	10/18/2010
Sho KIM	10/20/2010
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SANYO CHEMICAL INDUSTRIES, LTD.
<b>Street Address:</b>	11-1, Ikkyo Nomoto-cho, Higashiyama-ku
<b>City:</b>	Kyoto-shi, Kyoto
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	605-0995
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	12991596
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(202)822-1111
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
<b>Phone:</b>	2028221100
<b>Email:</b>	PatentMail@Whdapatentlaw.com
<b>Correspondent Name:</b>	Westerman, Hattori, Daniels & Adrian LLP
<b>Address Line 1:</b>	1250 Connecticut Avenue NW,
<b>Address Line 2:</b>	Suite 700
<b>Address Line 4:</b>	Washington,, DISTRICT OF COLUMBIA 20036
<b>ATTORNEY DOCKET NUMBER:</b>	101283
<b>NAME OF SUBMITTER:</b>	Shuji Yoshizaki
<b>Total Attachments: 1</b> source=101283_Assignment_11_02_2010#page1.tif	

OP \$40.00 12991596

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**PATENT**  
**REEL: 025342 FRAME: 0123**

**U.S. ASSIGNMENT**(Insert ASSIGNEE's  
Name(s) Address(es))

FOR GOOD AND VALUABLE CONSIDERATION, the adequacy and receipt of which is hereby acknowledged by the undersigned inventor(s) (hereinafter ASSIGNOR) by

**SANYO CHEMICAL INDUSTRIES, LTD.****11-1, Ikkyo Nomoto-cho, Higashiyama-ku****Kyoto-shi Kyoto, 605-0995 JAPAN**

(hereinafter ASSIGNEE), the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

(Title of Invention)

**RESIN PARTICLE AND PROCESS FOR PRODUCTION THEREOF**

for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

filed on \_\_\_\_\_ Application No. \_\_\_\_\_

(Westerman, Hattori, Daniels &amp; Adrian, LLP is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)

and all Letters Patent of the United States to be obtained therefore on said application or any continuation, divisional, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with the application and any continuation, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, divisional, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Signatures)

Yasuhiro SHINDO

(Signature)

Yasuhiro SHINDO

(Type Name)

October 18, 2010

(Date)

Sho KIM

(Signature)

Sho KIM

(Type Name)

October 20, 2010

(Date)

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(Signature)

(Type Name)

(Date)

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(Signature)

(Type Name)

(Date)

NO LEGALIZATION REQUIRED

**PATENT**